



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification#20240628014.0
Device symbolization update for Select Devices
Information Only**

Date: June 29, 2024
To: PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the Change Management team.

Sincerely,

Change Management Team
SC Business Services

20240628014.0
Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
SN74LVC2G125DCTR	NULL
SN74LVC2G74DCTRE4	NULL
SN74LVC3G17DCTRE4	NULL

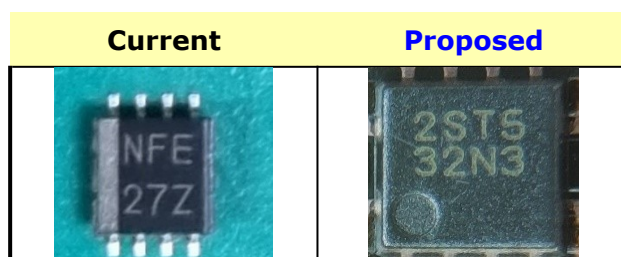
Technical details of this Product Change follow on the next page(s).

Notification Number:	20240628014.0	Notification Date:	June 29, 2024
Title:	Device symbolization update for select Devices		
Customer Contact:	Change Management team	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an update to the device symbolization for the devices shown below (pin one stripe to dot and 3 to 4 character) below as follows:



Reason for Change:

Standardization

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Device marking change only

Changes to product identification resulting from this notification:

Device marking change only.

Product Affected:

74LVC1G123DCTRE4	SN74AUC2G79DCTR	SN74LVC2G08DCTR	SN74LVC2G80DCTRG4
74LVC1G123DCTRG4	SN74AUC2G80DCTR	SN74LVC2G08DCTRE4	SN74LVC2G86DCTR
74LVC1G123DCTTE4	SN74AUC2G86DCTR	SN74LVC2G08DCTRG4	SN74LVC3G04DCTR
74LVC1G123DCTTG4	SN74AUP1G99DCTR	SN74LVC2G125DCTR	SN74LVC3G04DCTRG4
74LVC1G139DCTRE4	SN74AUP1G99DCTT	SN74LVC2G126DCTR	SN74LVC3G06DCTR
74LVC2G125DCTRE4	SN74AXC2T45DCTR	SN74LVC2G132DCTR	SN74LVC3G07DCTR
74LVC2G125DCTRG4	SN74LVC1404DCTR	SN74LVC2G157DCTR	SN74LVC3G14DCTR
74LVC2G126DCTRG4	SN74LVC1G123DCTR	SN74LVC2G157DCTRG4	SN74LVC3G14DCTRE4
74LVC2G132DCTRG4	SN74LVC1G123DCTT	SN74LVC2G240DCTR	SN74LVC3G17DCTR
74LVC2G157DCTRE4	SN74LVC1G139DCTR	SN74LVC2G241DCTR	SN74LVC3G17DCTRE4
74LVC2G241DCTRE4	SN74LVC1G139DCTT	SN74LVC2G32DCTR	SN74LVC3G17DCTRG4
74LVC2G241DCTRG4	SN74LVC1G29DCTR	SN74LVC2G32DCTRE4	SN74LVC3G34DCTR
SN74AUC2G00DCTR	SN74LVC1G74DCTR	SN74LVC2G32DCTRG4	SN74LVC3G34DCTRG4
SN74AUC2G02DCTR	SN74LVC1G99DCTR	SN74LVC2G38DCTR	SN74LVC3GU04DCTR
SN74AUC2G08DCTR	SN74LVC1G99DCTRG4	SN74LVC2G74DCTR	TXS0102DCTR

SN74AUC2G125DCTR	SN74LVC1G99DCTT	SN74LVC2G74DCTRE4	TXS0102DCTRE4
SN74AUC2G126DCTR	SN74LVC2G00DCTR	SN74LVC2G74DCTRG4	TXS0102DCTT
SN74AUC2G240DCTR	SN74LVC2G00DCTRE4	SN74LVC2G79DCTR	TXS0102DCTTE4
SN74AUC2G241DCTR	SN74LVC2G02DCTR	SN74LVC2G80DCTR	TXS0102DCTTG4
SN74AUC2G32DCTR	SN74LVC2G02DCTRE4		

For questions regarding this notice, e-mails can be sent to Change Management team or your local Field Sales Representative.

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